

**ProLight AJ2N-AA1FF**  
**1W Power LED**  
**Technical Datasheet**  
**Version: 1.1**

# ProLight Opto AJ2N Series

## Features

- Best thermal material solution of the world
- Best Moisture Sensitivity: JEDEC Level 1
- RoHS compliant
- AEC-Q101 Qualified
- SAE/ECE/GB compliant
- Good color uniformity
- Lead free reflow soldering

## Main Applications

- Bending light
- Cornering light
- Working light
- Warning light

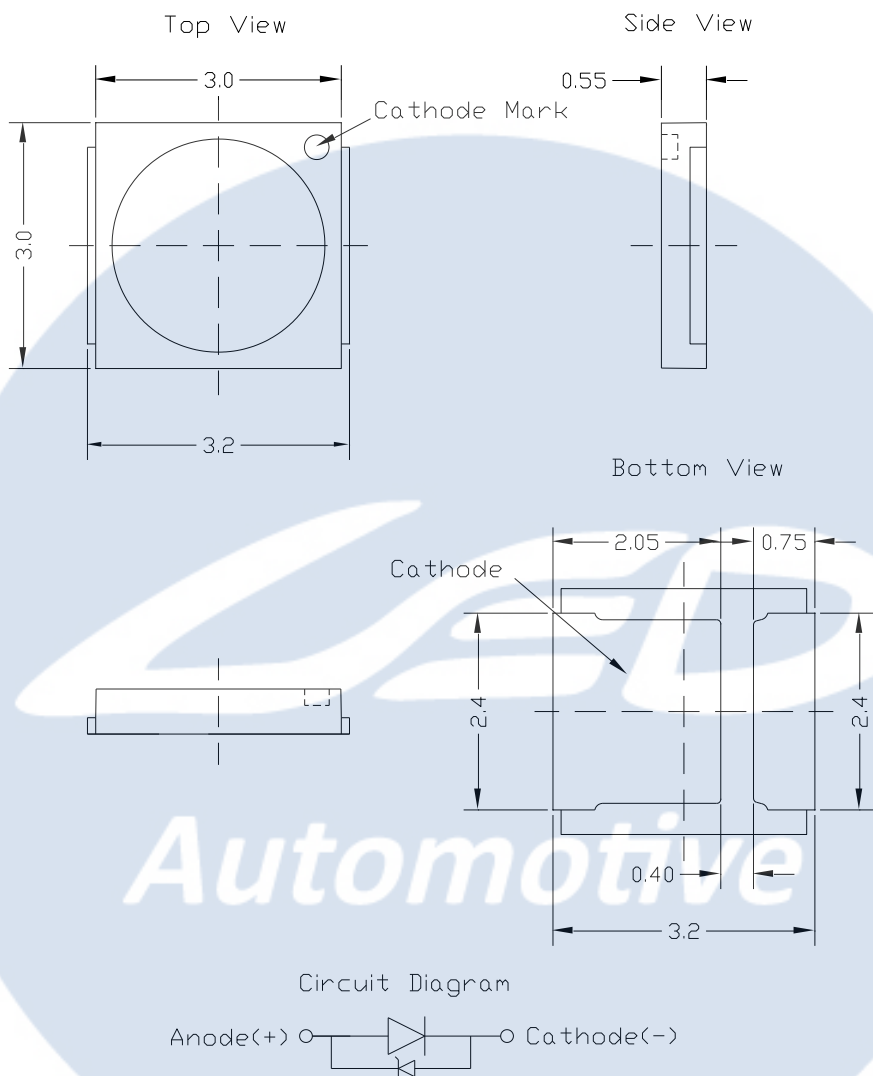
*Automotive*

## Introduction

Base on Prolight unique lead frame technology, AJ2N deliver high efficiency and best lumens per dollar which help customers to lower system cost and develop competitive outstanding automotive lighting.

AJ2N offer multi colors solution to meet the needs of bending lighting, fog lamp, day running light, cornering light, working light, and warning light. Alone with high-quality materials, AJ2N bring not only high performance but also good reliability to fulfil customer's requirements.

## Emitter Mechanical Dimensions



### Notes:

1. The cathode side of the device is denoted by the chamfer on the part body.
2. Drawing not to scale.
3. All dimensions are in millimeters.
4. Unless otherwise indicated, tolerances are  $\pm 0.10\text{mm}$ .
5. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
6. **Please do not use a force of over 0.3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

\*The appearance and specifications of the product may be modified for improvement without notice.

## Flux Characteristics at 350mA, $T_j = 25^{\circ}\text{C}$

Radiation Pattern	Color	Part Number Emitter	Luminous Flux $\Phi_v$ (lm)	
			Minimum	Typical
Lambertian	Amber	AJ2N-AA1FF	23.5	31.3

- ProLight maintains a tolerance of  $\pm 7\%$  on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

## Electrical Characteristics at 350mA, $T_j = 25^{\circ}\text{C}$

Color	Forward Voltage $V_F$ (V)			Thermal Resistance Junction to Slug ( $^{\circ}\text{C/W}$ )
	Min.	Typ.	Max.	
Amber	1.8	2.2	2.6	20

- ProLight maintains a tolerance of  $\pm 0.1\text{V}$  for Voltage measurements.

## Optical Characteristics at 350mA, $T_j = 25^{\circ}\text{C}$

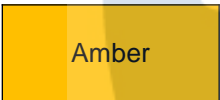
Radiation Pattern	Color	Dominant Wavelength $\lambda_D$			Total included Angle (degrees) $\theta_{0.90V}$	Viewing Angle (degrees) $2\theta_{1/2}$
		Min.	Typ.	Max.		
Lambertian	Amber	587 nm	592 nm	597 nm	160	120

- ProLight maintains a tolerance of  $\pm 1\text{nm}$  for dominant wavelength measurements.

## Absolute Maximum Ratings

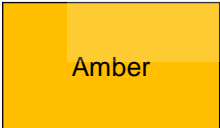
Parameter	Amber
DC Forward Current (mA)	350
Peak Pulsed Forward Current (mA)	450 (less than 1/10 duty cycle@1KHz)
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	±4000V (Class III)
LED Junction Temperature	120°C
Operating Board Temperature at Maximum DC Forward Current	-40°C - 90°C
Storage Temperature	-40°C - 120°C
Soldering Temperature	JEDEC 020c 260°C
Allowable Reflow Cycles	3
Reverse Voltage	Not designed to be driven in reverse bias

## Photometric Luminous Flux Bin Structure

Color	Bin Code	Minimum Photometric Flux (lm)	Maximum Photometric Flux (lm)	Available Color Bins
	P	23.5	30.6	All
	Q	30.6	39.8	【1】
	R	39.8	51.7	【1】

- ProLight maintains a tolerance of  $\pm 7\%$  on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- <sup>【1】</sup> The rest of color bins are not 100% ready for order currently. Please ask for quote and order Possibility.

## Dominant Wavelength Bin Structure

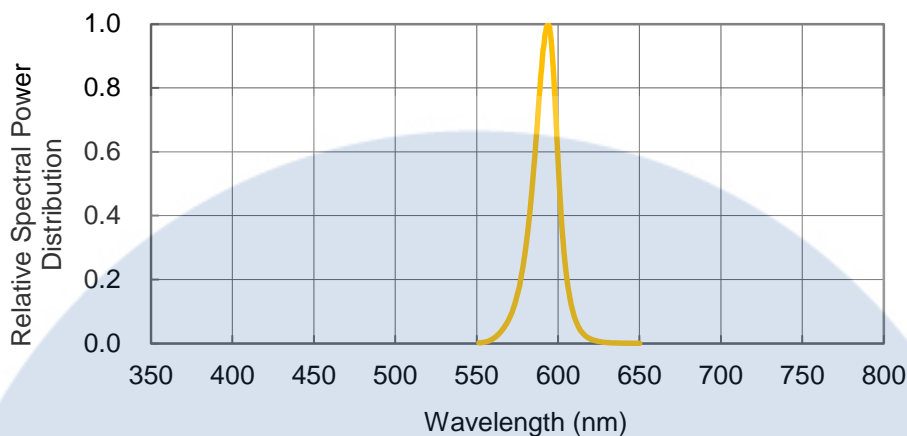
Color	Bin Code	Minimum Dominant Wavelength (nm)	Maximum Dominant Wavelength (nm)
	2	587.0	589.5
	4	589.5	592.0
	6	592.0	594.5
	7	594.5	597.0

- ProLight maintains a tolerance of  $\pm 1\text{nm}$  for dominant wavelength measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

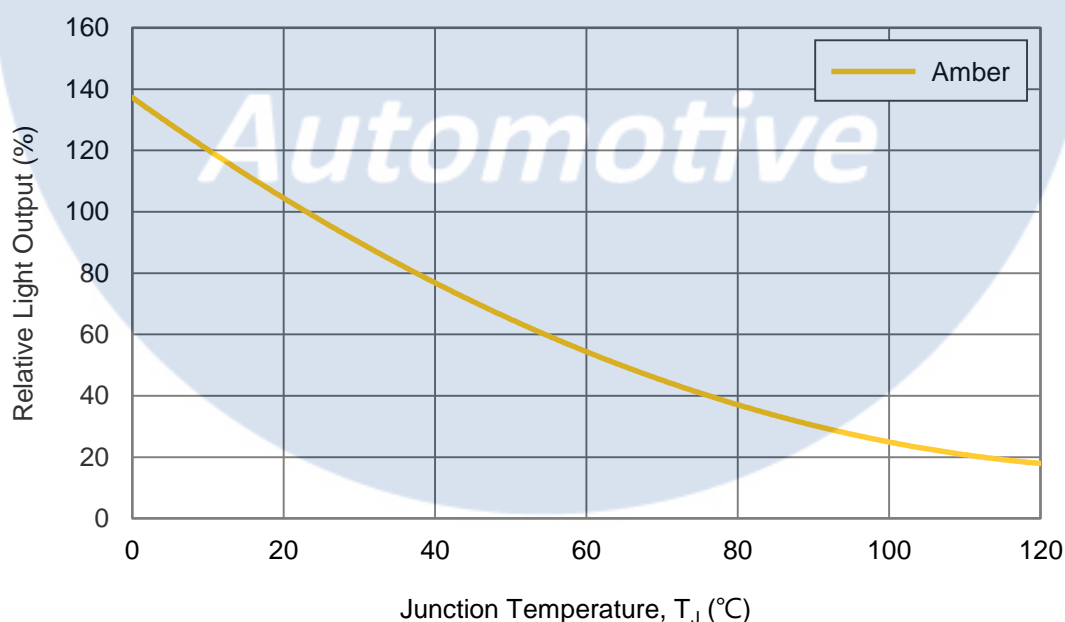
## Color Spectrum, $T_J = 25^\circ\text{C}$

### 1. Amber

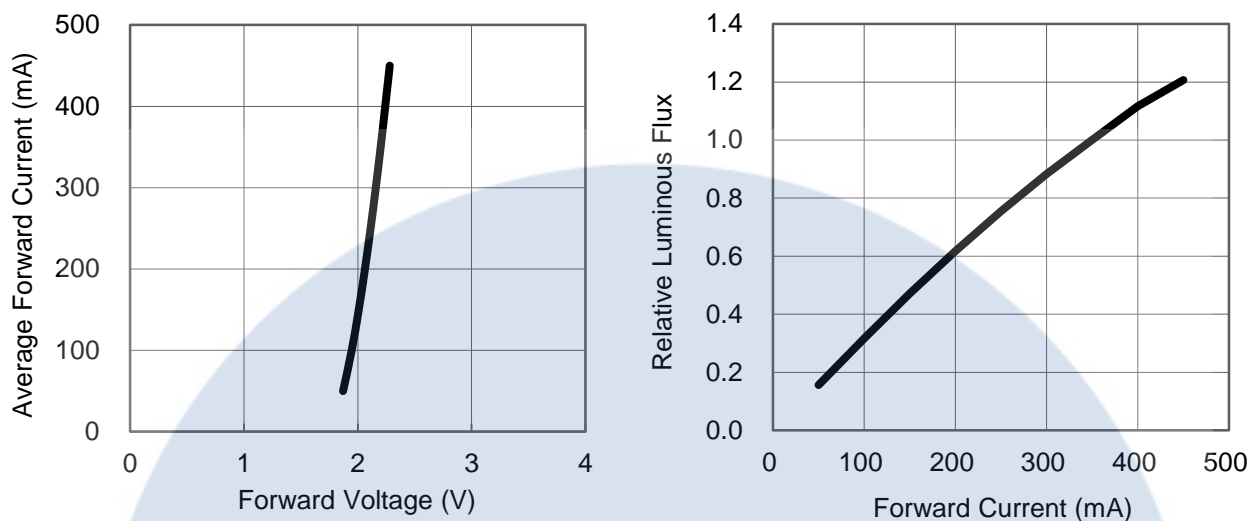


## Light Output Characteristics

Relative Light Output vs. Junction Temperature at 350mA

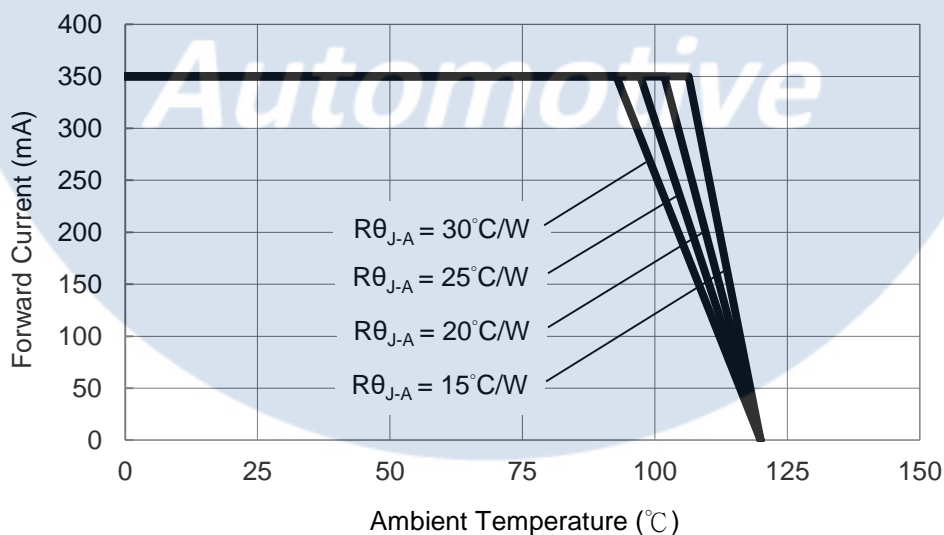


## Forward Current Characteristics, $T_j = 25^\circ\text{C}$

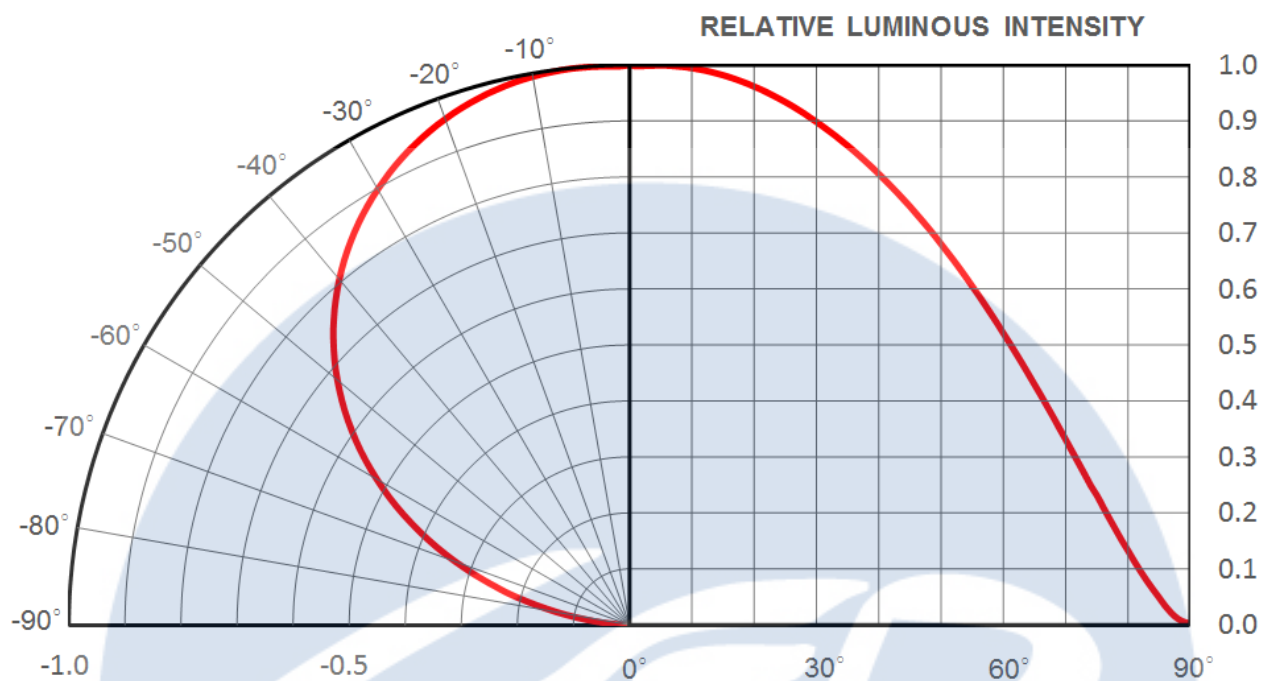


## Ambient Temperature vs. Maximum Forward Current

1. Amber ( $T_{JMAX} = 120^\circ\text{C}$ )



## Typical Representative Spatial Radiation Pattern



## Moisture Sensitivity Level – JEDEC Level 1

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	$\leq 30^{\circ}\text{C}$ / 85% RH	168 +5/-0	$85^{\circ}\text{C}$ / 85% RH	NA	NA

- The standard soak time includes a default value of 24 hours for semiconductor manufacture's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	$\leq 30^{\circ}\text{C}$ / 85% RH	168 +5/-0	$85^{\circ}\text{C}$ / 85% RH	NA	NA
2	1 year	$\leq 30^{\circ}\text{C}$ / 60% RH	168 +5/-0	$85^{\circ}\text{C}$ / 60% RH	NA	NA
2a	4 weeks	$\leq 30^{\circ}\text{C}$ / 60% RH	696 +5/-0	$30^{\circ}\text{C}$ / 60% RH	120 +1/-0	$60^{\circ}\text{C}$ / 60% RH
3	168 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	192 +5/-0	$30^{\circ}\text{C}$ / 60% RH	40 +1/-0	$60^{\circ}\text{C}$ / 60% RH
4	72 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	96 +2/-0	$30^{\circ}\text{C}$ / 60% RH	20 +0.5/-0	$60^{\circ}\text{C}$ / 60% RH
5	48 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	72 +2/-0	$30^{\circ}\text{C}$ / 60% RH	15 +0.5/-0	$60^{\circ}\text{C}$ / 60% RH
5a	24 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	48 +2/-0	$30^{\circ}\text{C}$ / 60% RH	10 +0.5/-0	$60^{\circ}\text{C}$ / 60% RH
6	Time on Label (TOL)	$\leq 30^{\circ}\text{C}$ / 60% RH	Time on Label (TOL)	$30^{\circ}\text{C}$ / 60% RH	NA	NA



## Reliability testing in accordance with AEC-Q101 (Rev D1)

The development of this product included extensive operational life-time testing and environmental testing. Table 1 summarizes the tests applied and cumulative test results obtained from testing performed in accordance with AEC-Q101(Rev D1).

**Table 1. Operating life, mechanical and environmental tests performed on it's package in accordance with AEC-Q101 (Rev D1).**

Abrb Stress	Conditions	Duration	Failure Criteria	Rejects
<b>TEST</b> Pre- and Post-Stress Electrical Test	$T_J = 25^{\circ}\text{C}$	N/A	See notes [2]	0
<b>PC</b> Pre-conditioning	JESD22-A113 Soak $T_{\text{amb}} = 85^{\circ}\text{C}$ , RH = 85% Reflow soldering	168 hours 3 cycles	See notes [2]	0
<b>EV</b> External Visual	JESD22 B-101	N/A	See notes [2]	0
<b>HTFB</b> High Temperature Forward Bias	JESD22-A108 $T_{\text{amb}} = 85^{\circ}\text{C}$ , IF = max. DC [1]	1000 hours	See notes [2]	0
<b>TC</b> Temperature Cycling	JESD22-A104 $-30^{\circ}\text{C}$ to $80^{\circ}\text{C}$	1000 cycles	See notes [2]	0
<b>HTHHB</b> High temp. & High Humidity Bias	JESD22-A101 $T_{\text{amb}} = 85^{\circ}\text{C}$ , RH = 85%, IF = max. DC [1]	1000 hours	See notes [2]	0
<b>PTC</b> Power and Temperature cycle	$-30^{\circ}\text{C}$ to $85^{\circ}\text{C}$ , 10 minutes dwell, 20 minutes transfer (1 hour cycle), 2 minutes ON/2 minutes OFF, IF = max. DC [1]	1000 hours	See notes [2]	0
<b>ESD</b>	AEC Q101-001	8000V	See notes [2]	0
<b>VVF</b> Vibration Variable Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis	--	See notes [3]	0
<b>MS</b> Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis	--	See notes [3]	0
<b>RSH</b> Resistance to Solder Heat	JESD22-A111 / JESD22-B106 $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$	10 s	See notes [3]	0
<b>SD</b> Solderability	J-STD-002 $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$	3 s	See notes [3]	0

Notes:

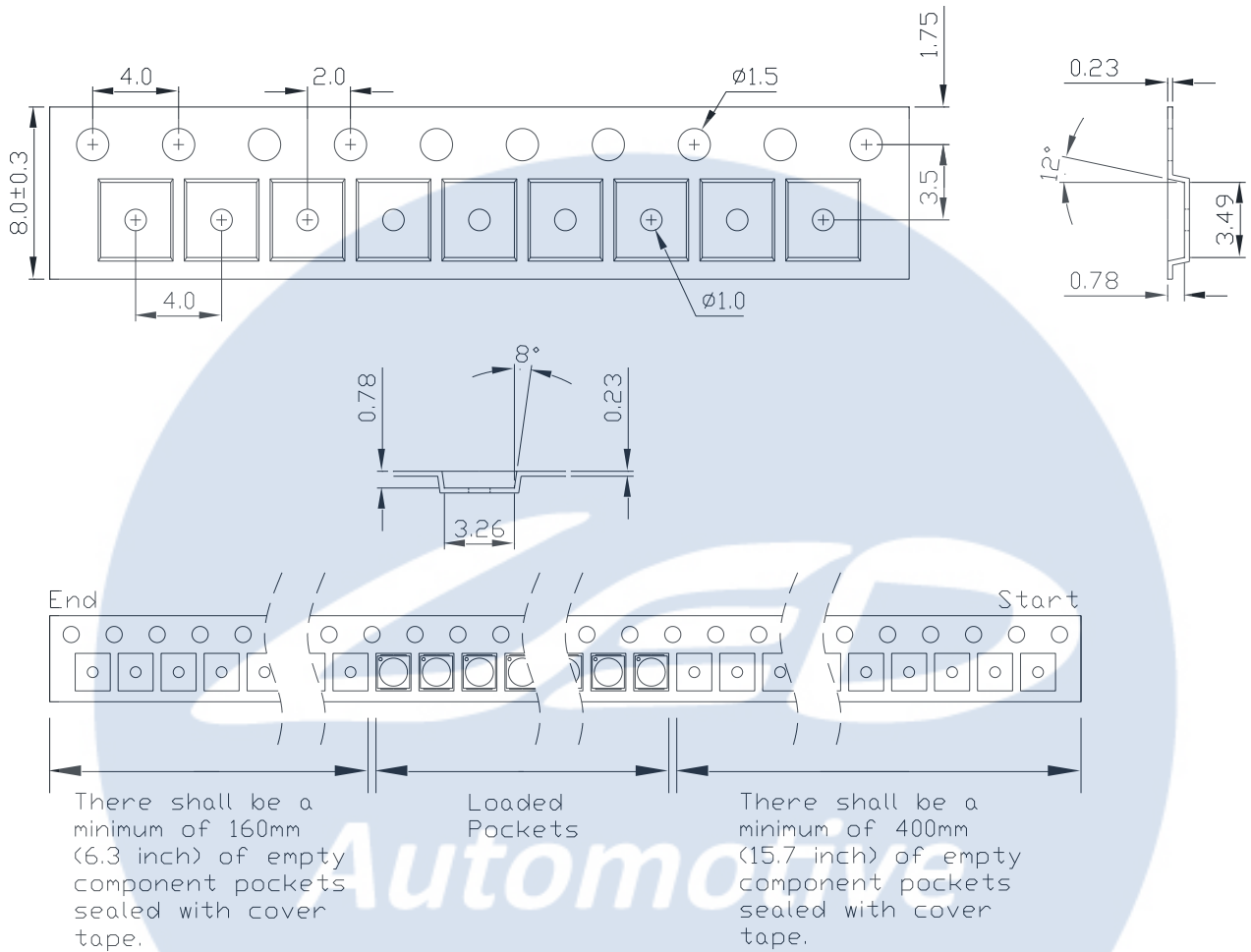
- Depending on the maximum derating curve.
- Criteria for judging failure

Item	Test Condition	Criteria for Judgement	
		Min.	Max.
Forward Voltage ( $V_F$ )	$I_F = \text{max DC}$	--	Initial Level x 1.1
Luminous Flux or Radiometric Power ( $\Phi_V$ )	$I_F = \text{max DC}$	Initial Level x 0.8	--
Reverse Current ( $I_R$ )	$V_R = 5\text{V}$	--	50 $\mu\text{A}$

\* The test is performed after the LED is cooled down to the room temperature.

- A failure is an LED that is open or shorted.

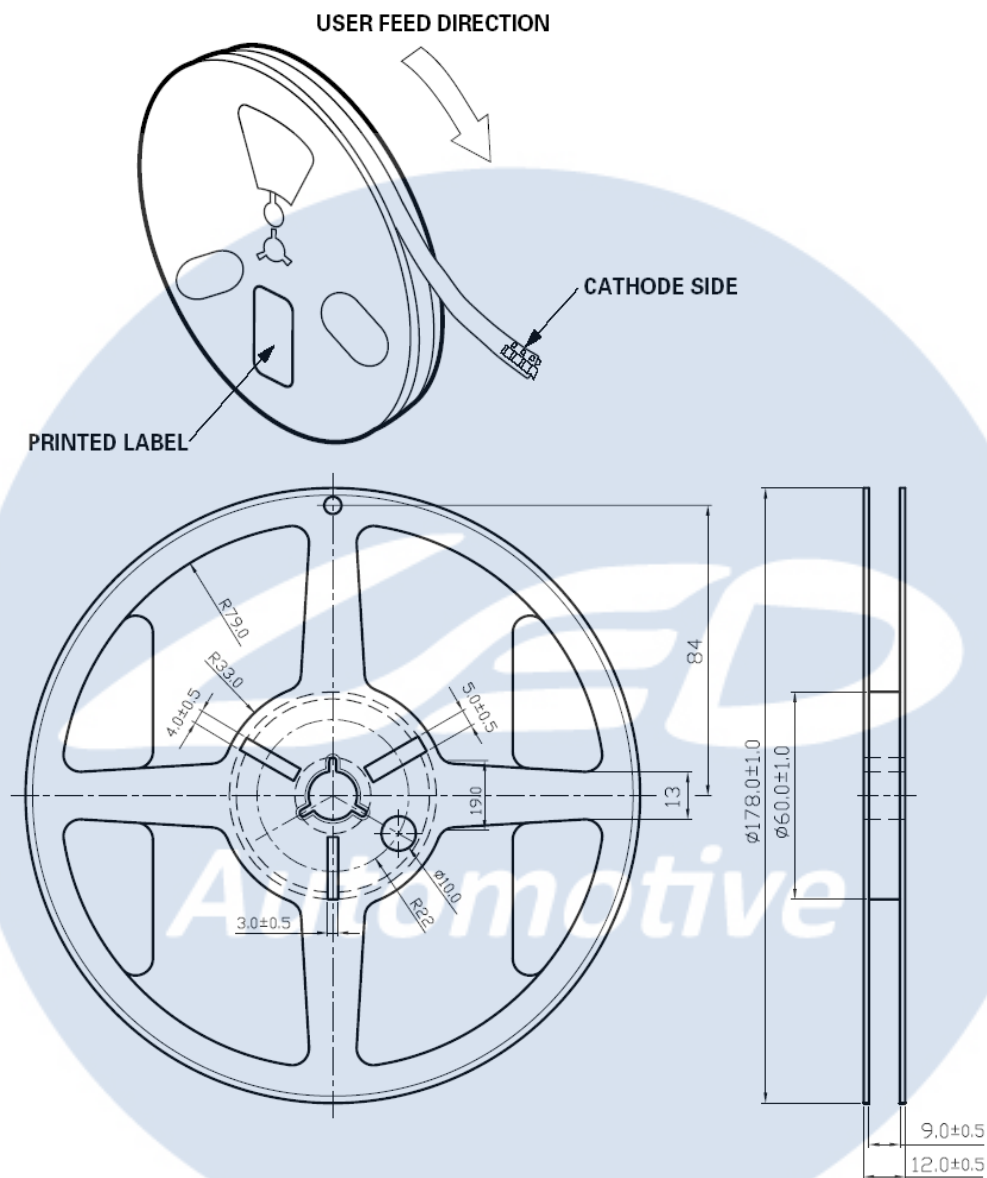
## Emitter Reel Packaging



### Notes:

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are  $\pm 0.10$  mm.

## Emitter Reel Packaging



### Notes:

1. Empty component pockets sealed with top cover tape.
2. 3000 pieces per reel.
3. Drawing not to scale.
4. All dimensions are in millimeters.

## Precaution for Use

- Storage

Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseat the MBB.

- The slug is not electrically neutral. Therefore, we recommend to isolate the heat sink.

- **We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.**

- **Do not use solder pastes with post reflow flux residue > 47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.**

- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.

- Please avoid rapid cooling after soldering.

- Components should not be mounted on warped direction of PCB.

- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.

- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.

- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets.

<http://www.prolightopto.com/>

## Handling of Silicone LEDs

Notes for handling of silicone LEDs

- Please do not use a force of over 0.3kgf impact or pressure on the silicone, otherwise it will cause a catastrophic failure.

- The LEDs should only be picked up by making contact with the sides of the LED body.

- Avoid touching the silicone especially by sharp tools such as Tweezers.

- Avoid leaving fingerprints on the silicone.

- Please store the LEDs away from dusty areas or seal the product against dust.

- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.

- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)

